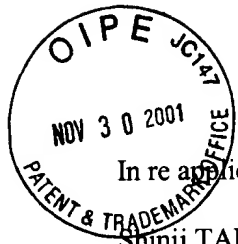


9 / Supp.
188
12-6-01
Ratner



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Shinji TAKEDA et al.

Serial No. 09/785,194

Filed: February 20, 2001

For: SEMICONDUCTOR DEVICE AND
PROCESS FOR FABRICATION
THEREOF

)
) Atty. Docket No.: **TM&K0006**
)
) Group Art Unit: 1755
)
) Examiner:
)
)
) Date: November 30, 2001
)

RECEIVED
DEC 3 2001
TC 1700

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

This is a Supplemental Information Disclosure Statement with regard to the above-identified application. Copies of each of the documents listed in the attached Form PTO/SB/08A are attached.

Document A relates to an electrically resistive, highly densified diamond-packed thermal conduit. Document B relates to a semiconductor device and its manufacturing method. Document C relates to electrically conductive bonding films. Document D relates to an epoxy resin composition. Document E relates to a thermally stable adhesive. Document F relates to an optical shutter array and a method for making it. Document G relates to a housing for electromagnetic interference shielding. Document H relates to compliant and crosslinkable thermal interface materials. Document I relates to polyimide and doped metal oxide fuser components. Document J relates to cast lubricating films and their composites.

Documents A, B, and C were cited in the Office Action dated September 25, 2001 in applicants' corresponding U.S. Application Serial No. 09/785,436. Documents D, E, F, G, H, I, and J were cited in the Office Action dated October 29, 2001 in applicants' corresponding U.S. Application Serial No.

RECEIVED
DEC 5 2001
TC 283 MAIL ROOM

Serial No. 09/785,194


09/616,943. No items of information contained in this information disclosure statement were cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned attorney for applicants after making reasonable inquiry, no item of information contained in this information disclosure statement was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of this information disclosure statement.

It is respectfully requested that the attached documents be considered and officially cited, and that a copy of the Form PTO/SB/08A, initialed by the Examiner to indicate that the documents have been considered, be returned to the applicants.

Since no Office Action has issued in this case, it is believed that no fee is required. However, if it is determined that a fee is required, authorization is hereby given to deduct said fee from the undersigned's Deposit Account No. 50-1281.

Respectfully submitted,

GRIFFIN & SZIPL, P.C.



Joerg-Uwe Szimpl
Registration No. 31,799

GRIFFIN & SZIPL, P.C.
Suite PH-1
2300 Ninth Street, South
Arlington, VA 22204

Telephone: (703) 979-5700
Facsimile: (703) 979-7429
Customer No.: 24203

RECEIVED
MEL-5 2001
10 2600 MAIL ROOM